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**Please add claims 13-20 as follows:**

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--13. (Amended) An SAW filter device including an SAW filter according to claim 2, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

14. (Amended) An SAW filter device including an SAW filter according to claim 3, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

15. (Amended) An SAW filter device including an SAW filter according to claim 4, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

16. (Amended) An SAW filter device including an SAW filter according to claim 5, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip

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substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

17. (Amended) An SAW filter device including an SAW filter according to claim 6, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

18. (Amended) An SAW filter device including an SAW filter according to claim 7, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

19. (Amended) An SAW filter device including an SAW filter according to claim 8, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

20. (Amended) An SAW filter device including an SAW filter according to claim 9, which comprises a plastic package including a terminal member made of metal extending out of the

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package and extending into the package such as to form an L-shaped portion, the chip  
substrate being accommodated in the plastic package such that the back surface of the chip  
substrate is in contact with the L-shaped portion. --

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